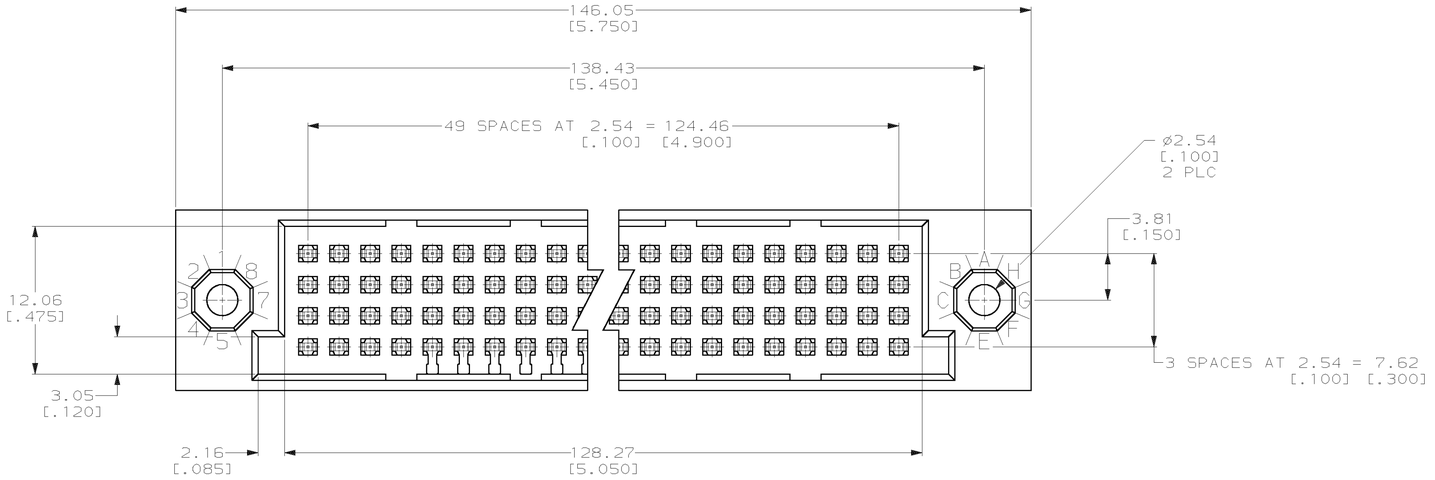
THIS DRAWING IS UNPUBLISHED. RELEASED FOR PUBLICATION ,19 .
© COPYRIGHT 19 BY AMP INCORPORATED. ALL RIGHTS RESERVED.

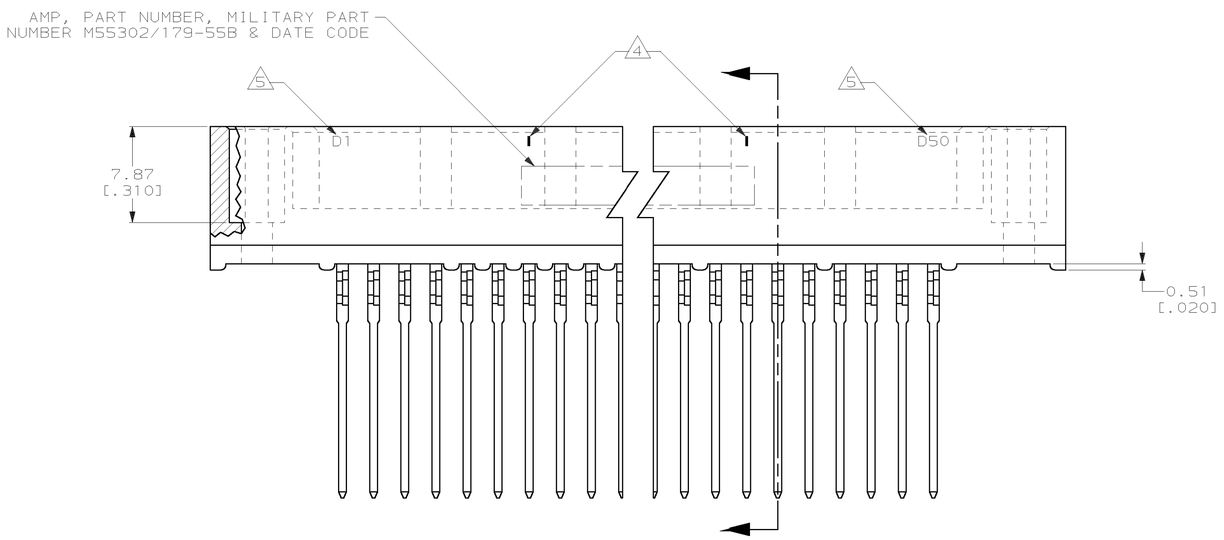
LOC	DIST
AD	25

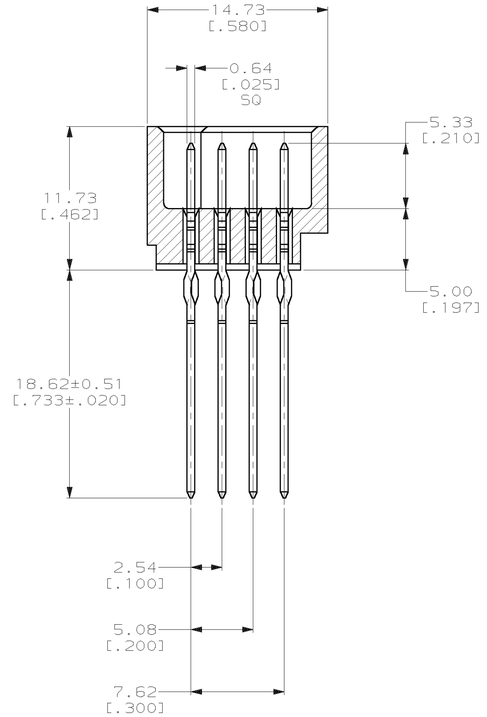
REVISIONS

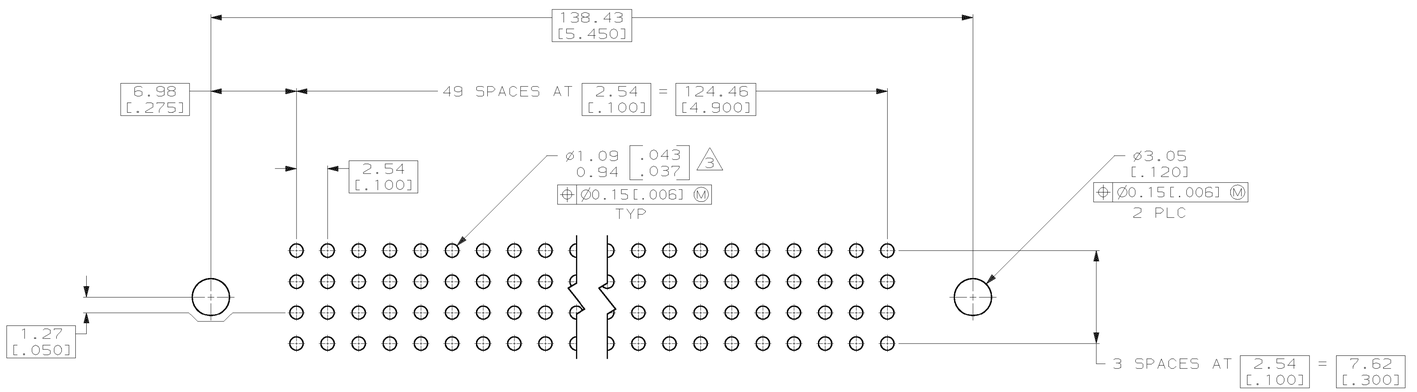
P	LTR	DESCRIPTION	DATE	DWN	APVD
	0	RELEASED -4	09 MAY 00	–	–



1. HOUSING: THERMOPLASTIC, NATURAL.
   CONTACT: PHOSPHOR BRONZE.
2. CONTACT: 1.27µm-2.54µm[.000050-.000100] NICKEL UNDERPLATE ALL OVER, 1.27µm[.000050] MIN GOLD PLATE IN CONTACT AREA, TIN-LEAD PLATED POSTS.
3. RECOMMENDED PCB HOLES ARE ø1.151[.0453] PLATED THROUGH WITH 0.02-0.08[.001-.003] COPPER WITH 0.008[.0003] MIN TIN-LEAD PLATING. FINISHED HOLE AFTER PLATING 0.94-1.09[.037-.043].
4. MARK EVERY TENTH POSITION.
5. MARK ROW D AND FIRST-LAST POSITION IDENTIFICATION.







RECOMMENDED PC BOARD LAYOUT

NO OF POSN	PART NUMBER
200	533932-4

THIS DRAWING IS A CONTROLLED DOCUMENT.

DIMENSIONS: mm [INCHES]

TOLERANCES UNLESS OTHERWISE SPECIFIED.

0 PLC	±–
1 PLC	±–
2 PLC	±0.13 [.005]
3 PLC	±–
4 PLC	±–
ANGLES	±–

MATERIAL 1 FINISH 2

DWN B.CARBO 09 MAY 00
CHK W.MILLHIMES –
APVD W.MILLHIMES
PRODUCT SPEC –
APPLICATION SPEC –
WEIGHT –

CUSTOMER DRAWING

AMP Incorporated
Harrisburg, PA 17105-3608

NAME HDI, 4 ROW, PIN ASSEMBLY, 200 POSITION, .000050 MIN GOLD / TIN-LEAD

SIZE	CAGE CODE	DRAWING NO	RESTRICTED TO
A1	00779	C- 533932	–

SCALE	SHEET	REV
4:1	1 OF 1	0